

UM4601/4611/8601/8611

Multi-line ESD/EMI Protection for Color LCD Interfaces UM4601 DFN8 2.0×2.0 UM4611 DFN8 1.7×1.3 UM8601 DFN16 4.0×1.6 UM8611 DFN16 3.3×1.3

General Description

The UM4601/UM4611/UM8601/UM8611 is a (L-C) low pass filter array with integrated TVS diodes. It is designed to suppress unwanted EMI signals and provide electrostatic discharge (ESD) protection in portable electronic equipment. This device utilizes solid-state silicon-avalanche technology for superior clamping performance and DC electrical characteristics. They have been optimized for protection of color LCD and camera lines in cellular phones and other portable electronics.

The device consists of identical circuits comprised of TVS diodes for ESD protection, and an inductor - capacitor network for EMI filtering. A typical inductor value of 17nH and a capacitor value of 15pF are used to achieve 24dB minimum attenuation from 800MHz to 2.7GHz. The TVS diodes provide effective suppression of ESD voltages in excess of ± 15 kV (air discharge) and ± 8 kV (contact discharge) per IEC 61000-4-2, level 4.

The UM4601 is in a RoHS compliant DFN8 2.0×2.0 package, the UM4611 is in a RoHS compliant DFN8 1.7×1.3 package, the UM8601 is in a RoHS compliant DFN16 4.0×1.6 package and the UM8611 is in a RoHS compliant DFN16 3.3×1.3 package. The leads are finished with lead-free. The small package makes it ideal for use in portable electronics such as cell phones, digital still cameras, and PDAs.

Applications

- Color LCD Protection
- Cell Phone CCD Camera Lines
- Clamshell Cell Phones

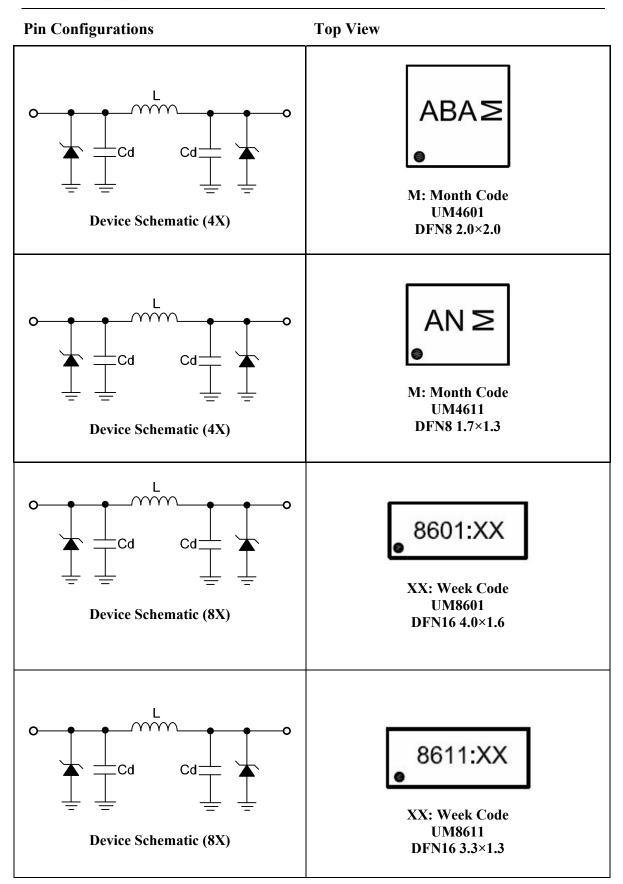
Features

- Bidirectional EMI Filter with Integrated TVS for ESD Protection
- ESD Protection to IEC 61000-4-2 (ESD) Level 4, ±15kV (air), ±8kV (contact)
- Filter performance: 24dB minimum attenuation from 800MHz to 2.7GHz
- TVS Working Voltage: 5V
- Inductor: 17nH (Typical)
- Capacitors: 15pF (Typical at $V_R = 2.5V$)
- Protection and filtering for multi lines UM4601/4611: four lines
- UM8601/8611: eight linesSolid-state Technology
- Working Part Packaging Marking Channel **Shipping Qty** Voltage Number Type Code DFN8 2.0×2.0 4 UM4601 5.0V ABA UM4611 5.0V DFN8 1.7×1.3 4 AN 3000pcs /7Inch DFN16 4.0×1.6 Tape & Reel UM8601 5.0V 8 8601 UM8611 5.0V DFN16 3.3×1.3 8 8611

Ordering Information



UM4601/4611/8601/8611





Absolute Maximum Ratings

PARAMETER	SYMBOL	VALUE	UNIT
ESD per IEC 61000-4-2(Air) ESD per IEC 61000-4-2(Contact)	V_{ESD}	+/- 20 +/- 15	kV
Junction Temperature	T _J	125	°C
Operating Temperature Range	T _{OP}	-40 to 85	°C
Storage Temperature Range	T _{STG}	-55 to 150	°C

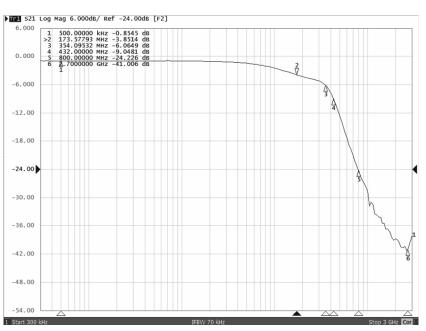
Electrical Characteristics

($T_J=25$ °C unless otherwise noted)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNIT
TVS Reverse Stand-Off Voltage	V _{RWM}				5	V
TVS Reverse Breakdown Voltage	V_{BR}	It = 1mA	6	8	10	V
TVS Reverse Leakage Current	I _R	$V_{RWM} = 3.3V$			0.1	μΑ
DC Resistance	R _{cc}			10		Ω
Roll-off frequency at -6dB Attenuation	f_R	Z source = Z_{load} = 50 Ω		350		MHZ
Filter Cut-Off Frequency	fc	Z source = Z_{load} = 50 Ω		150		MHZ
Inductance	L			17		nH
Capacitance	Cd	$V_R = 2.5V, f = 1MHZ$		15		pF
Total Capacitance	C _{total}	Input to Gnd, Each Line V _R =2.5V,f=1MHZ	24	30	36	pF

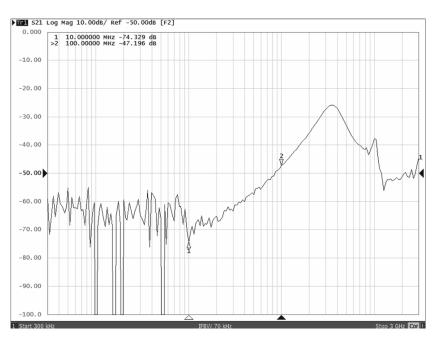


Typical Operating Characteristics



Typical Insertion Loss

Analog Crosstalk





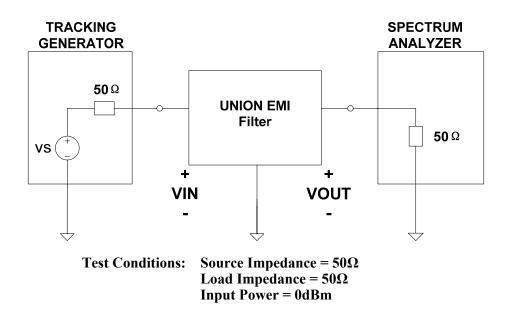
Applications Information

Insertion Loss

Insertion Loss (IL) is used to describe the transmission coefficient between two points in a circuit often described in terms of dB. When examining S parameters, S21 is often described as insertion loss. Insertion Loss and S21 will be used interchangeably from here on out. The insertion loss of a circuit with VOUT and VIN would be expressed as

 $IL = S_{21}(dB) = 20 \log (V_{OUT}/V_{IN})$

The setup for measuring insertion loss in a 50 Ω system is shown in the figure below. It will be analyzed in a 50 Ω environment, so the source impedance and load impedance is 50 Ω . The transfer functions then can be analyzed in terms of insertion loss (S21).



Cut Off Frequency

Cut off Frequency is the frequency at which the signal strength is 3.0 dB less than it is Pass Band 3.0 dB of attenuation equates to half the original signal power. The Pass Band is the range of frequencies that are allowed to "pass" through a filter with minimal attenuation. For our purposes it starts from DC and ends at the cut off frequency.

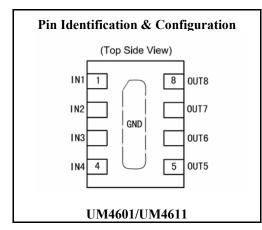
Device Connection

The UM4601/UM4611/UM8601/UM8611 is comprised of identical circuits consisting of a low pass filter for EMI suppression and dual TVS diodes for ESD protection. The device is in an 8-pin DFN and 16-pin DFN package. Electrical connection is made to all the pins located at the bottom of the device. A center tab serves as the ground connection. The device has a flow through design for easy layout. All path lengths should be kept as short as possible to minimize the effects of parasitic inductance in the board traces.

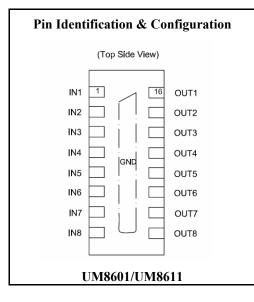


Ground Connection Recommendation

Parasitic inductance (L) present in the board layout will affect the filtering performance of the device. As frequency (f) increases, the effect of the inductance becomes more dominant. This effect is given by Equation 1.



Pin	Identification
1 - 4	Input Lines
5 - 8	Output Lines
Center Tab	Ground
Equation 1: The Impeda Frequency XLF XLF(L,f) = 2×π×f×L	ance of an inductor at
Where: L= Inductance (H) f = Frequency (Hz)	



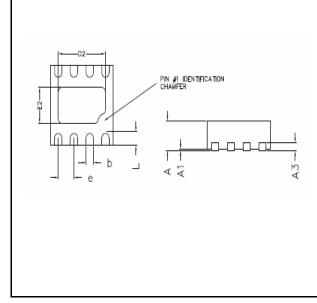
1 - 8 9 - 16 Center Tab	Input Lines Output Lines
	Output Lines
Center Tab	
eenter ruo	Ground
$KLF(L, f) = 2 \times \pi \times f \times L$ Where: z = parasitic inductance i f = Frequency (Hz)	n the PCB (H)



Package Information

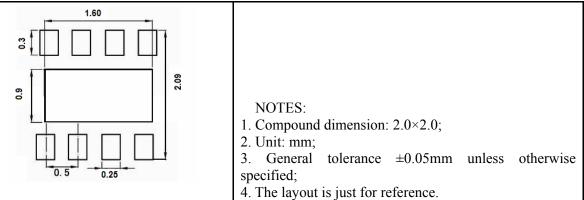
UM4601: DFN8 2.0×2.0

Outline Drawing



	DIMEN	ISIONS	
Sumbol	MILLIMETERS		
Symbol	Min	Тур	Max
D	1.95	2.00	2.05
Е	1.95	2.00	2.05
D2	1.35	1.50	1.65
А	0.57	0.69	0.80
A1	0	0.02	0.05
A3	-	0.152	0.20
b	0.18	0.25	0.30
E2	0.75	0.90	1.00
L	0.20	0.30	0.40
e	-	0.50	-

Land Pattern

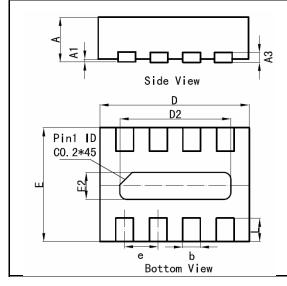






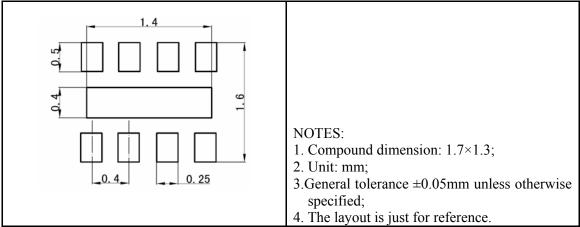
UM4611: DFN8 1.7×1.3

Outline Drawing



	DIMEN	SIONS	
Symbol	MILLIMETERS		
Symbol	Min	Тур	Max
D	1.624	1.70	1.776
Е	1.25	1.30	1.426
D2	1.10	1.40	1.70
E2	0.20	0.30	0.50
А	0.47	0.55	0.60
A1	0	0.02	0.05
A3	-	0.15	-
b	0.13	0.20	0.25
L	0.15	0.25	0.35
e	-	0.40	-

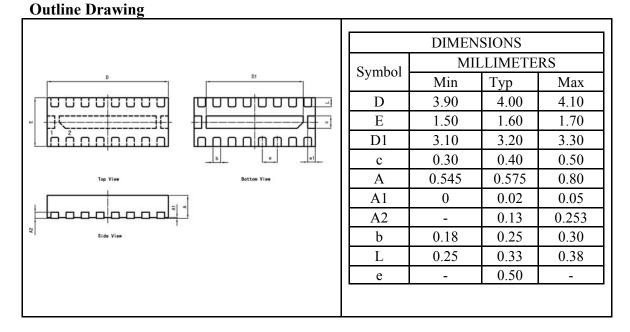
Land Pattern



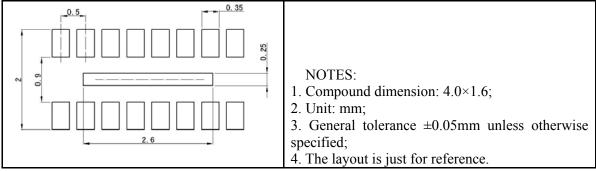




UM8601: DFN16 4.0×1.6



Land Pattern

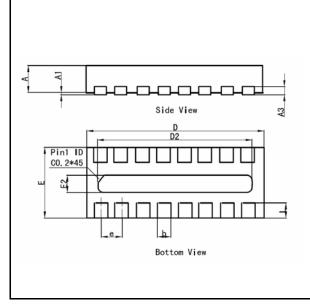






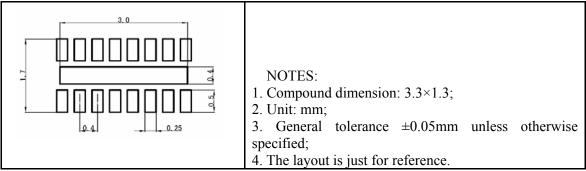
UM8611: DFN16 3.3×1.3

Outline Drawing



	DIMEN	ISIONS	
Symbol	MI	LLIMETE	RS
Symbol	Min	Тур	Max
D	3.224	3.30	3.376
Е	1.25	1.30	1.426
D2	2.45	2.90	3.00
E2	0.20	0.30	0.50
А	0.47	0.55	0.60
A1	-	0.02	0.05
A3	-	0.15	-
b	0.13	0.20	0.25
L	0.17	0.25	0.37
e	-	0.40	-

Land Pattern







IMPORTANT NOTICE

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